





SURFACE MOUNT SWITCHING DIODE ARRAY

Features

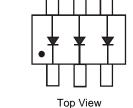
- Fast Switching Speed
- Low Forward Voltage: Maximum of 0.715V at 1mA
- Fast Reverse Recovery: Maximum of 4ns
- Low Capacitance: Maximum of 1.5pF
- Low Leakage Current
- Ultra-Small Surface Mount Package
- Thermally Efficient Copper Alloy leadframe for High Power Dissipation
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOT563
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Copper Alloy leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Weight: 0.003 grams (approximate)



Top View



Ordering Information (Note 4)

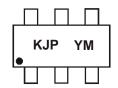
Part Number	Case	Packaging
BAS16V V-7	SOT563	3000/Tape & Reel

Bottom View

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For Packaging Details, go to our website at http://www.diodes.com.

Marking Information



KJP = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Z = 2012) M = Month (ex: 9 = September)

Date Code Key

Date Code Ney												
Year	201	2	2013		2014	20	15	2016		2017	:	2018
Code	Z		Α		В	(C	D		E		F
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@ $T_A = 25^{\circ}C$ unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Non-Repetitive Peak Reverse Voltage	Peak Reverse Voltage V _{RM}		100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	100	V
RMS Reverse Voltage	V _{R(RMS)}	71	V	
Forward Continuous Current (Note 5)	I _{FM}	200	mA	
@ t = 1.0μs @ t = 1.0ms @ t = 1.0ms @ t = 1.0s		I _{FSM}	4.0 1.0 0.5	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	350	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{ hetaJA}$	357	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = 25°C unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)		100	_	V	$I_R = 100 \mu A$
	V _F	_	0.715	V	I _F = 1.0mA
Forward Voltage		_	0.855		$I_F = 10 \text{mA}$
orward voltage		_	1.0		$I_F = 50 \text{mA}$
		_	1.25		$I_F = 150 \text{mA}$
		_	0.5	μΑ	$V_R = 80V$
Leakage Current (Note 6)	I _R	_	50	μΑ	$V_R = 80V, T_J = 150^{\circ}C$
Leakage Current (Note 6)		_	30	μΑ	V _R = 25V, T _J = 150°C
		_	30	nA	$V_R = 25V$
Total Capacitance	C _T	_	1.5	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t _{rr}	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

Notes:

- 5. Device mounted on FR-4 PCB, on minimum recommended, 2oz copper pad layout.
- 6. Short duration pulse test used to minimize self-heating effect.

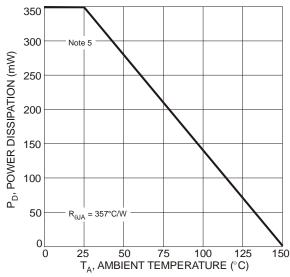
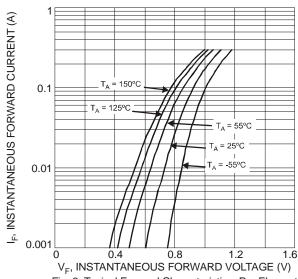
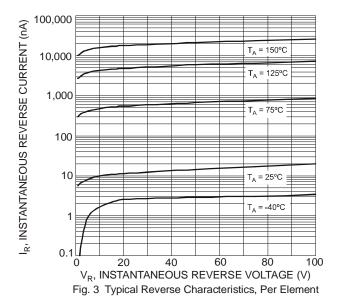


Fig. 1 Power Derating Curve, Total Package







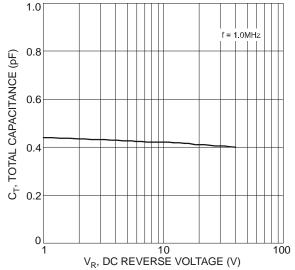
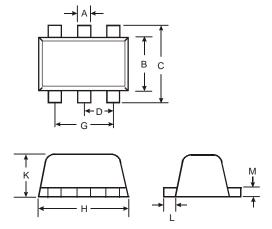


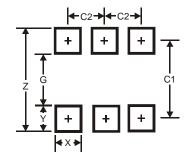
Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

Package Outline Dimensions



SOT563						
Dim	Min	Max	Тур			
Α	0.15	0.30	0.20			
В	1.10	1.25	1.20			
O	1.55	1.70	1.60			
D	-	-	0.50			
G	0.90	1.10	1.00			
Н	1.50	1.70	1.60			
K	0.55	0.60	0.60			
L	0.10	0.30	0.20			
M	0.10	0.18	0.11			
All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.2
G	1.2
Х	0.375
Υ	0.5
C1	1.7
C2	0.5



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Website:

Welcome to visit www.ameya360.com

Contact Us:

> Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

Customer Service :

Email service@ameya360.com

Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com